



# THE DATASHEET OF 74ALVC16836ADGG



# 74ALVC16836A

20-bit registered driver with inverted register enable; 3-state

Rev. 2 — 12 September 2018

Product data sheet

## 1. General description

The 74ALVC16836A is a 20-bit universal bus driver. Data flow is controlled by active low output enable ( $\overline{OE}$ ), active low latch enable ( $\overline{LE}$ ) and clock inputs (CP).

When  $\overline{LE}$  is LOW, the A to Y data flow is transparent. When  $\overline{LE}$  is HIGH and CP is held at LOW or HIGH, the data is latched; on the LOW to HIGH transient of CP the A-data is stored in the latch/flip-flop.

When  $\overline{OE}$  is LOW the outputs are active. When  $\overline{OE}$  is HIGH, the outputs go to the high impedance OFF-state. Operation of the  $\overline{OE}$  input does not affect the state of the latch/flip-flop.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

## 2. Features and benefits

- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- Direct interface with TTL levels
- Current drive  $\pm 24$  mA at 3.0 V
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple  $V_{CC}$  and GND pins for minimum noise and ground bounce
- Output drive capability 50  $\Omega$  transmission lines at 85°C
- Input diodes to accommodate strong drivers
- Complies with JEDEC standard no. 8-1A
- Complies with JEDEC standards:
  - JESD8-5 (2.3 V to 2.7 V)
  - JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM ANSI/ESDA/JEDEC JS-001 exceeds 2000 V
  - CDM JESD22-C101E exceeds 1000 V

## 3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74ALVC16836ADGG	-40 °C to +85 °C	TSSOP56	plastic thin shrink small outline package; 56 leads; body width 6.1 mm	SOT364-1

4. Functional diagram

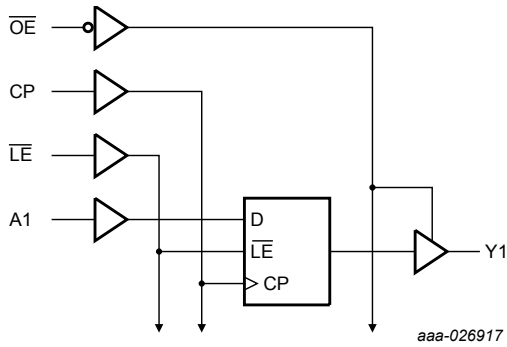


Fig. 1. Logic diagram

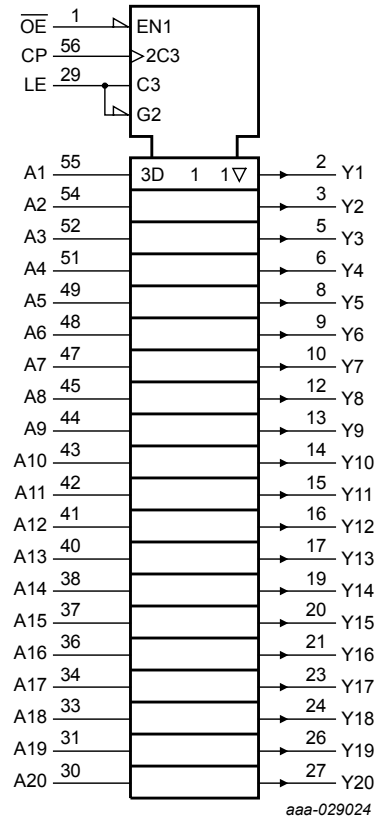


Fig. 2. Logic symbol (IEEE/IEC)

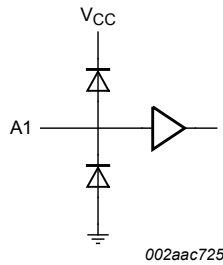
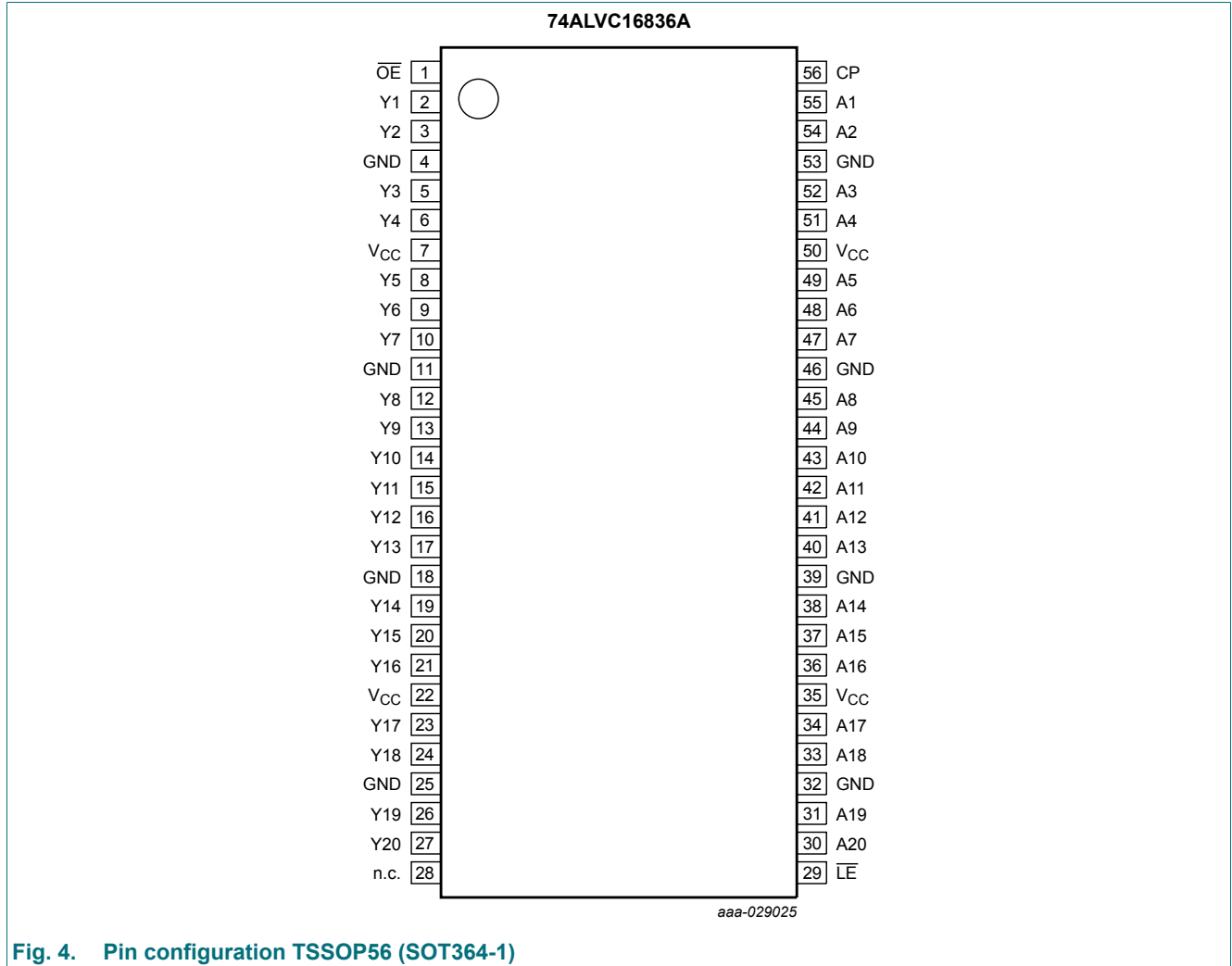


Fig. 3. Typical input (data or control)

## 5. Pinning information

### 5.1. Pinning



**Fig. 4.** Pin configuration TSSOP56 (SOT364-1)

## 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
A1, A2, A3, A4, A5, A6, A7, A8, A9, A10, A11, A12, A13, A14, A15, A16, A17, A18, A19, A20	55, 54, 52, 51, 49, 48, 47, 45, 44, 43, 42, 41, 40, 38, 37, 36, 34, 33, 31, 30	data inputs
Y1, Y2, Y3, Y4, Y5, Y6, Y7, Y8, Y9, Y10, Y11, Y12, Y13, Y14, Y15, Y16, Y17, Y18, Y19, Y20	2, 3, 5, 6, 8, 9, 10, 12, 13, 14, 15, 16, 17, 19, 20, 21, 23, 24, 26, 27	data outputs
n.c.	28	no connection
$\overline{\text{LE}}$	29	latch enable input (active LOW)
$\overline{\text{OE}}$	1	output enable input (active LOW)
CP	56	clock input (LOW-to-HIGH, edge-triggered)
GND	4, 11, 18, 25, 32, 39, 46, 53	ground (0 V)
V <sub>CC</sub>	7, 22, 35, 50	supply voltage

## 6. Functional description

Table 3. Function table [1]

Input				Output
OE	LE	CP	An	Yn
H	X	X	X	Z
L	L	X	L	L
L	L	X	H	H
L	H	↑	L	L
L	H	↑	H	H
L	H	H	X	Y <sub>0</sub> [2]
L	H	L	X	Y <sub>0</sub> [3]

[1] H = HIGH voltage level;

L = LOW voltage level;

X = don't care;

Z = high-impedance OFF-state;

↑ = LOW-to-HIGH clock transition.

[2] Y<sub>0</sub> = Output level before the indicated steady-state input conditions were established, provided that CP is high before  $\overline{\text{LE}}$  goes low.

[3] Y<sub>0</sub> = Output level before the indicated steady-state input conditions were established.

## 7. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+4.6	V
$V_I$	input voltage	For control inputs [1]	-0.5	+4.6	V
		For data inputs [1]	-0.5	$V_{CC} + 0.5$	V
$V_O$	output voltage	[1]	-0.5	$V_{CC} + 0.5$	V
$I_{IK}$	input clamping current	$V_I < 0$ V	-50	-	mA
$I_{OK}$	output clamping current	$V_O > V_{CC}$ or $V_O < 0$ V	-	$\pm 50$	mA
$I_{O (sink/source)}$	output sink or source current	$V_O = 0$ V to $V_{CC}$	-	$\pm 50$	mA
$I_{CC}$	supply current		-	100	mA
$I_{GND}$	ground current		-100	-	mA
$T_{stg}$	storage temperature		-65	+150	°C
$P_{tot}$	total power dissipation	[2]	-	600	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP56 package:  $P_{tot}$  derates linearly with 8 mW/K above 55 °C.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{CC}$	supply voltage	maximum speed performance				
		$V_{CC} = 2.5$ V; $C_L = 30$ pF	2.3	-	2.7	V
		$V_{CC} = 3.3$ V; $C_L = 50$ pF	3.0	-	3.6	V
		LOW-voltage applications	1.2	-	3.6	V
$V_I$	input voltage		0	-	$V_{CC}$	V
$V_O$	output voltage		0	-	$V_{CC}$	V
$T_{amb}$	ambient temperature	operating in free-air	-40	-	+85	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 2.3$ V to 3.0 V	0	-	20	ns/V
		$V_{CC} = 3.0$ V to 3.6 V	0	-	10	ns/V

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).  $T_{amb} = -40\text{ °C}$  to  $+85\text{ °C}$

Symbol	Parameter	Conditions	Min	Typ [1]	Max	Unit
$V_{IH}$	HIGH-level input voltage	$V_{CC} = 2.3\text{ V}$ to $2.7\text{ V}$	1.7	1.2	-	V
		$V_{CC} = 2.7\text{ V}$ to $3.6\text{ V}$	2.0	1.5	-	V
$V_{IL}$	LOW-level input voltage	$V_{CC} = 2.3\text{ V}$ to $2.7\text{ V}$	-	1.2	0.7	V
		$V_{CC} = 2.7\text{ V}$ to $3.6\text{ V}$	-	1.5	0.8	V
$V_{OH}$	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$V_{CC} = 2.3\text{ V}$ to $3.6\text{ V}$ ; $I_O = -100\text{ }\mu\text{A}$	$V_{CC} - 0.2$	$V_{CC}$	-	V
		$V_{CC} = 2.3\text{ V}$ ; $I_O = -6\text{ mA}$	$V_{CC} - 0.3$	$V_{CC} - 0.08$	-	V
		$V_{CC} = 2.3\text{ V}$ ; $I_O = -12\text{ mA}$	$V_{CC} - 0.6$	$V_{CC} - 0.26$	-	V
		$V_{CC} = 2.7\text{ V}$ ; $I_O = -12\text{ mA}$	$V_{CC} - 0.5$	$V_{CC} - 0.14$	-	V
		$V_{CC} = 3.0\text{ V}$ ; $I_O = -12\text{ mA}$	$V_{CC} - 0.6$	$V_{CC} - 0.09$	-	V
		$V_{CC} = 3.0\text{ V}$ ; $I_O = -24\text{ mA}$	$V_{CC} - 1.0$	$V_{CC} - 0.28$	-	V
$V_{OL}$	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$V_{CC} = 2.3\text{ V}$ to $3.6\text{ V}$ ; $I_O = 100\text{ }\mu\text{A}$	-	GND	0.20	V
		$V_{CC} = 2.3\text{ V}$ ; $I_O = 6\text{ mA}$	-	0.07	0.40	V
		$V_{CC} = 2.3\text{ V}$ ; $I_O = 12\text{ mA}$	-	0.15	0.70	V
		$V_{CC} = 2.7\text{ V}$ ; $I_O = 12\text{ mA}$	-	0.14	0.40	V
		$V_{CC} = 3.0\text{ V}$ ; $I_O = 24\text{ mA}$	-	0.27	0.55	V
$I_I$	input leakage current	$V_{CC} = 2.3\text{ V}$ to $3.6\text{ V}$ ; $V_I = V_{CC}$ or GND	-	0.1	5	$\mu\text{A}$
$I_{OZ}$	OFF-state output current	$V_{CC} = 2.3\text{ V}$ to $3.6\text{ V}$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $V_O = V_{CC}$ or GND	-	0.1	10	$\mu\text{A}$
$I_{CC}$	supply current	$V_{CC} = 2.3\text{ V}$ to $3.6\text{ V}$ ; $V_I = V_{CC}$ or GND; $I_O = 0\text{ A}$	-	0.2	40	$\mu\text{A}$
$\Delta I_{CC}$	additional supply current	$V_{CC} = 2.3\text{ V}$ to $3.6\text{ V}$ ; $V_I = V_{CC} - 0.6\text{ V}$ ; $I_O = 0\text{ A}$	-	150	750	$\mu\text{A}$
$C_I$	input capacitance		-	4.0	-	pF
$C_{I/O}$	input/output capacitance		-	8.0	-	pF

- [1] Typical values are measured at  $T_{amb} = 25\text{ °C}$   
 Typical values for  $V_{CC} = 2.3\text{ V}$  to  $2.7\text{ V}$  are measured at  $V_{CC} = 2.5\text{ V}$   
 Typical values for  $V_{CC} = 3.0\text{ V}$  to  $3.6\text{ V}$  are measured at  $V_{CC} = 3.3\text{ V}$

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**

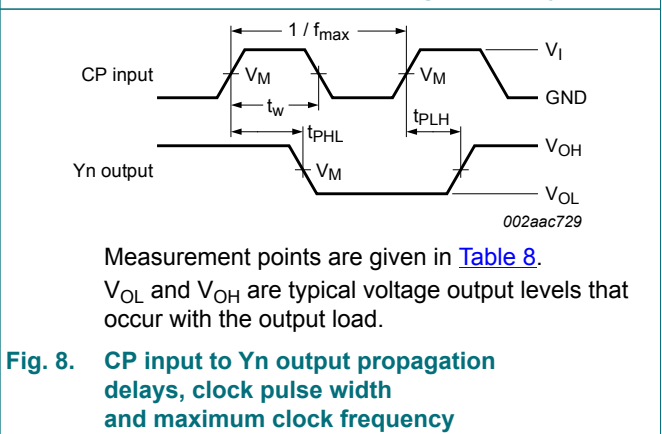
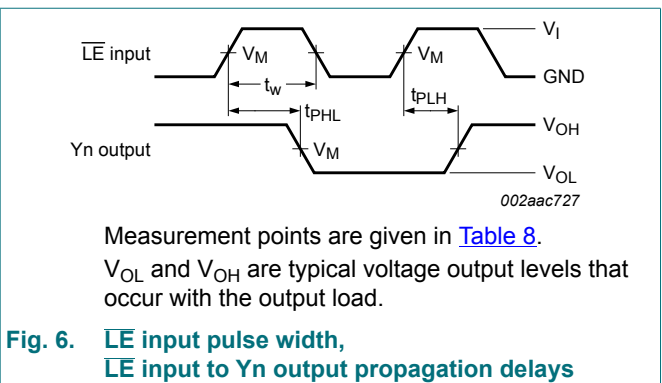
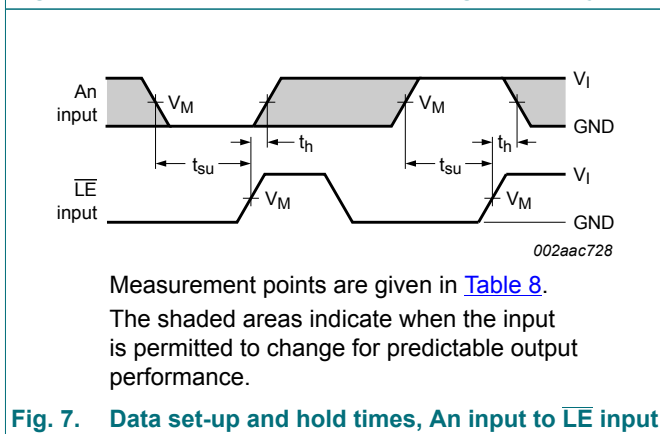
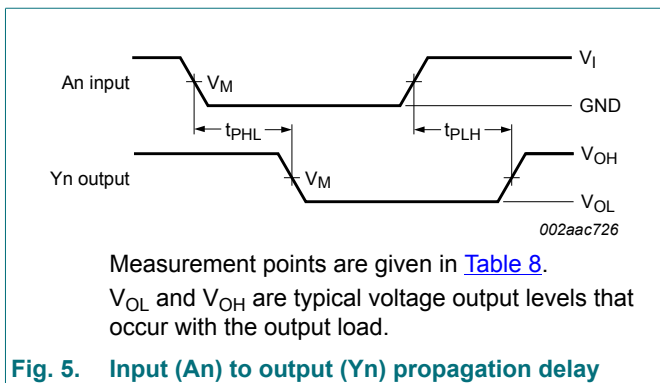
Voltages are referenced to GND (ground = 0 V). For test circuit, see Fig. 11.

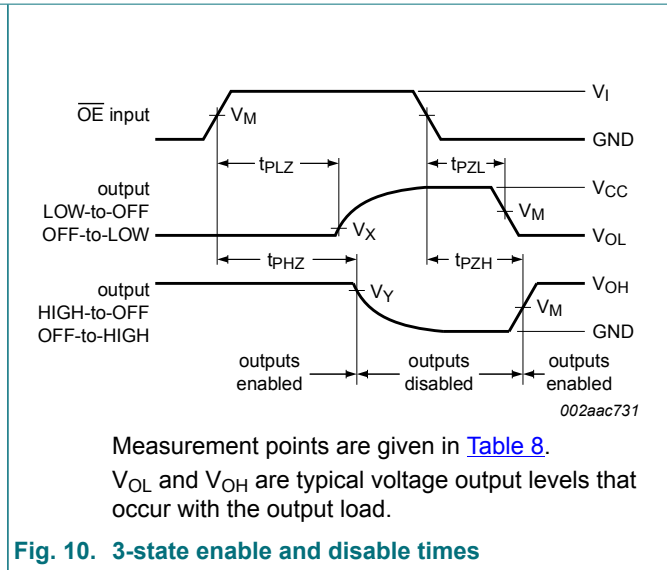
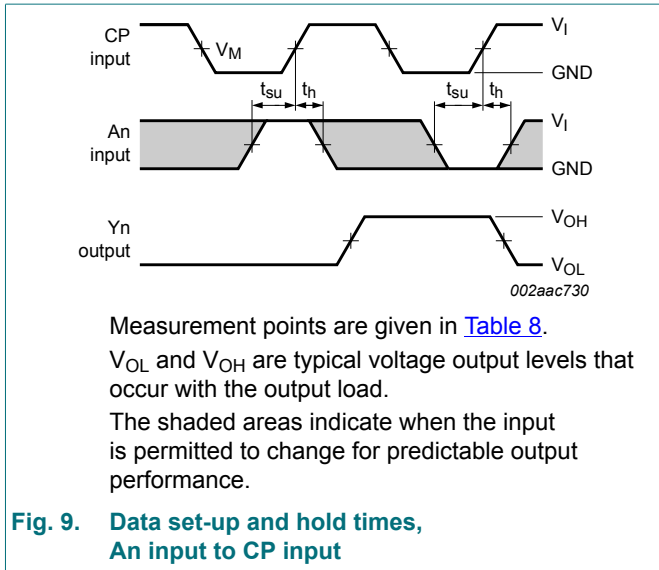
Symbol	Parameter	Conditions	Min	Typ [1]	Max	Unit
$t_{pd}$	propagation delay	An to Yn; see Fig. 5 [2]				
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.0	2.4	4.2	ns
		$V_{CC} = 2.7 \text{ V}$	1.3	2.7	4.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.0	2.3	3.6	ns
		$\overline{LE}$ to Yn; see Fig. 6				
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.3	2.8	4.5	ns
		$V_{CC} = 2.7 \text{ V}$	1.3	2.8	4.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.3	2.6	4.2	ns
		CP to Yn; see Fig. 8				
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.4	2.8	5.0	ns
		$V_{CC} = 2.7 \text{ V}$	1.3	2.7	4.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.3	2.5	4.2	ns
$t_{en}$	enable time	$\overline{OE}$ to Yn; see Fig. 10 [3]				
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.4	2.2	4.0	ns
		$V_{CC} = 2.7 \text{ V}$	1.4	3.0	4.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.1	2.3	4.4	ns
$t_{dis}$	disable time	$\overline{OE}$ to Yn; see Fig. 10 [4]				
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.4	2.0	4.5	ns
		$V_{CC} = 2.7 \text{ V}$	1.4	3.1	4.3	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.3	2.8	4.3	ns
$t_w$	pulse width	CP HIGH or LOW; $V_{CC} = 2.3 \text{ V to } 3.6 \text{ V}$ ; see Fig. 8	2.0	-	-	ns
		$\overline{LE}$ HIGH; $V_{CC} = 2.3 \text{ V to } 3.6 \text{ V}$ ; see Fig. 6	2.0	-	-	ns
$t_{su}$	set-up time	An to CP; $V_{CC} = 2.3 \text{ V to } 3.6 \text{ V}$ ; see Fig. 9	1.0	-	-	ns
		An to $\overline{LE}$ ; $V_{CC} = 2.3 \text{ V to } 3.6 \text{ V}$ ; see Fig. 7	1.5	-	-	ns
$t_h$	hold time	An to CP; see Fig. 9				
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	0.6	0.2	-	ns
		$V_{CC} = 2.7 \text{ V}$	0.6	0.3	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	0.9	0.3	-	ns
		An to $\overline{LE}$ ; see Fig. 7				
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.4	0.4	-	ns
		$V_{CC} = 2.7 \text{ V}$	1.7	0.4	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.4	0.3	-	ns
$f_{max}$	maximum frequency	CP; see Fig. 8				
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	150	300	-	MHz
		$V_{CC} = 2.7 \text{ V}$	200	350	-	MHz
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	150	300	-	MHz

Symbol	Parameter	Conditions	Min	Typ [1]	Max	Unit
C <sub>PD</sub>	power dissipation capacitance	per buffer; V <sub>I</sub> = GND to V <sub>CC</sub>	[5]			
		transparent mode; output enabled	-	13	-	pF
		transparent mode; output disabled	-	3	-	pF
		clocked mode; output enabled	-	22	-	pF
		clocked mode; output disabled	-	15	-	pF

- [1] Typical values are measured at T<sub>amb</sub> = 25 °C  
 Typical values for V<sub>CC</sub> = 2.3 V to 2.7 V are measured at V<sub>CC</sub> = 2.5 V  
 Typical values for V<sub>CC</sub> = 3.0 V to 3.6 V are measured at V<sub>CC</sub> = 3.3 V
- [2] t<sub>pd</sub> is the same as t<sub>PHL</sub> and t<sub>PLH</sub>.
- [3] t<sub>en</sub> is the same as t<sub>PZH</sub> and t<sub>PZL</sub>.
- [4] t<sub>dis</sub> is the same as t<sub>PHZ</sub> and t<sub>PLZ</sub>.
- [5] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW):  
 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o)$  where:  
 f<sub>i</sub> = input frequency in MHz;  
 f<sub>o</sub> = output frequency in MHz;  
 C<sub>L</sub> = output load capacitance in pF;  
 V<sub>CC</sub> = supply voltage in V;  
 N = number of inputs switching;  
 $\sum(C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

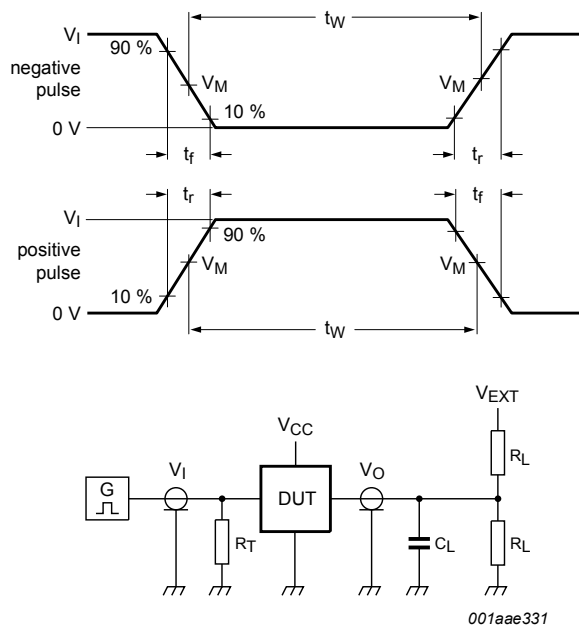
### 10.1. Waveforms and test circuit





**Table 8. Measurement points**

Supply voltage	Input		Output		
$V_{CC}$	$V_I$	$V_M$	$V_M$	$V_X$	$V_Y$
$\leq 2.3\text{ V}$	$V_{CC}$	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15\text{ V}$	$V_{OH} - 0.15\text{ V}$
2.3 V to 2.7 V	$V_{CC}$	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15\text{ V}$	$V_{OH} - 0.15\text{ V}$
2.7 V	2.7 V	1.5 V	1.5 V	$V_{OL} + 0.3\text{ V}$	$V_{OH} - 0.3\text{ V}$
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	$V_{OL} + 0.3\text{ V}$	$V_{OH} - 0.3\text{ V}$



Test data is given in [Table 9](#).

Definitions for test circuit:

$R_L$  = Load resistance.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

$V_{EXT}$  = External voltage for measuring switching times.

**Fig. 11. Test circuit for measuring switching times**

**Table 9. Test data**

Supply voltage	Input		Load		$V_{EXT}$		
$V_{CC}$	$V_I$	$t_r, t_f$	$C_L$	$R_L$	$t_{PLH}, t_{PHL}$	$t_{PLZ}, t_{PZL}$	$t_{PHZ}, t_{PZH}$
$\leq 2.3$ V	$V_{CC}$	$\leq 2.0$ ns	30 pF	500 $\Omega$	open	$2 \times V_{CC}$	GND
2.3 V to 2.7 V	$V_{CC}$	$\leq 2.0$ ns	30 pF	500 $\Omega$	open	$2 \times V_{CC}$	GND
2.7 V	2.7 V	$\leq 2.5$ ns	50 pF	500 $\Omega$	open	$2 \times V_{CC}$	GND
3.0 V to 3.6 V	2.7 V	$\leq 2.5$ ns	50 pF	500 $\Omega$	open	$2 \times V_{CC}$	GND

### 11. Package outline

TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1 mm

SOT364-1

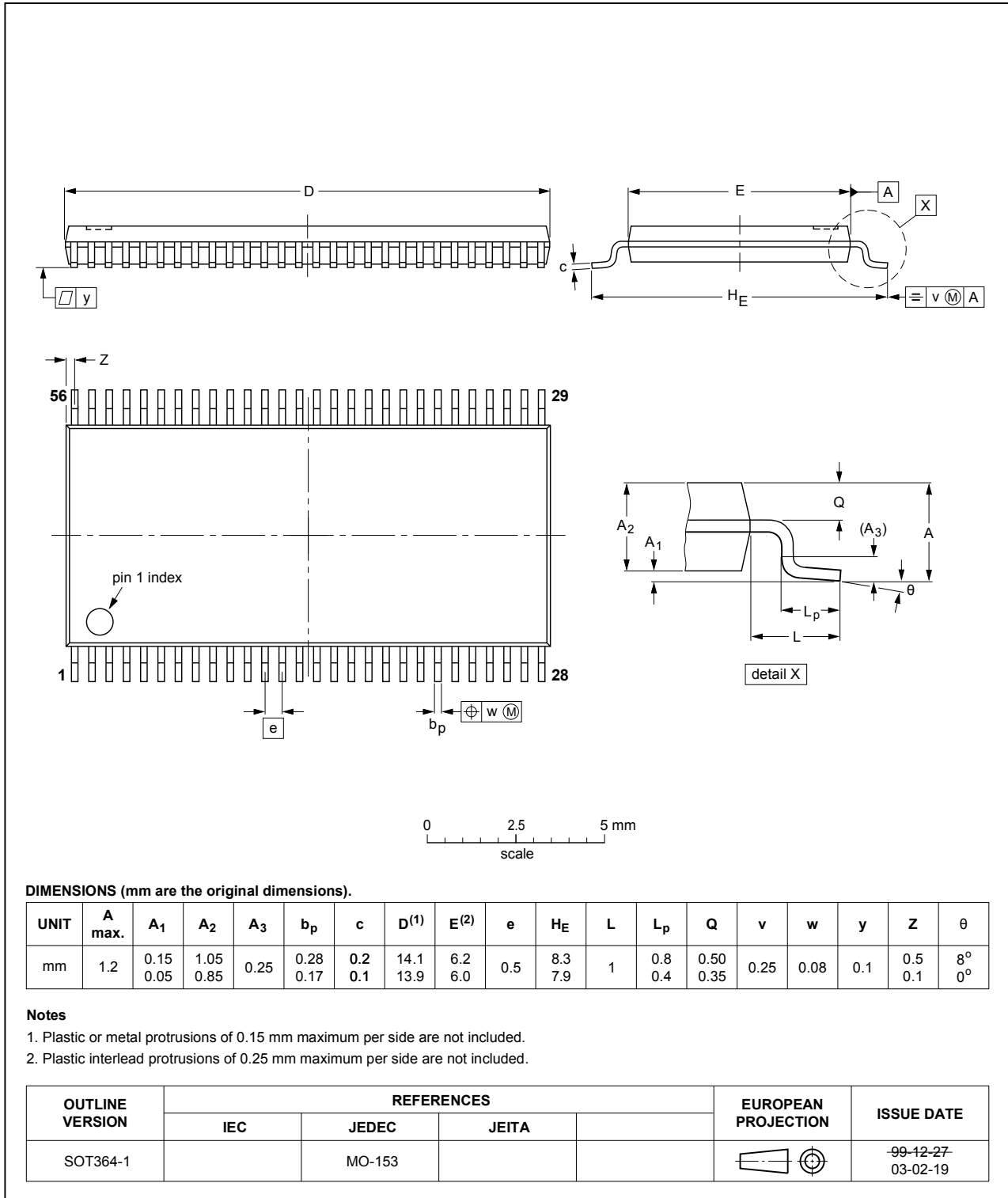


Fig. 12. Package outline SOT364-1 (TSSOP56)

## 12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
TTL	Transistor-Transistor Logic

## 13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74ALVC16836A v.2	20180912	Product data sheet	-	74ALVC16836A v.1
Modifications:	<ul style="list-style-type: none"> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>			
74ALVC16836A v.1	20000314	Product specification	-	-

## 14. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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## Contents

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<b>1. General description</b> .....	<b>1</b>
<b>2. Features and benefits</b> .....	<b>1</b>
<b>3. Ordering information</b> .....	<b>1</b>
<b>4. Functional diagram</b> .....	<b>2</b>
<b>5. Pinning information</b> .....	<b>3</b>
5.1. Pinning.....	3
5.2. Pin description.....	4
<b>6. Functional description</b> .....	<b>4</b>
<b>7. Limiting values</b> .....	<b>5</b>
<b>8. Recommended operating conditions</b> .....	<b>5</b>
<b>9. Static characteristics</b> .....	<b>6</b>
<b>10. Dynamic characteristics</b> .....	<b>7</b>
10.1. Waveforms and test circuit.....	8
<b>11. Package outline</b> .....	<b>11</b>
<b>12. Abbreviations</b> .....	<b>12</b>
<b>13. Revision history</b> .....	<b>12</b>
<b>14. Legal information</b> .....	<b>13</b>

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